



30V N-Channel MOSFETs

General Description

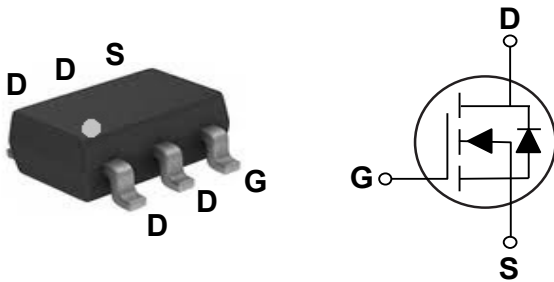
These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

BV_{DSS}	$R_{DS(ON)}$	I_D
30 V	28 mΩ	6 A

Features

- $R_{DS(ON)} \leq 28m\Omega @ V_{GS}=10V$
- Improved dv/dt capability
- Fast switching
- Green Device Available

SOT-23-6 Pin Configuration



Applications

- Battery Protection
- Load Switch
- Uninterruptible Power Supply

Absolute Maximum Ratings $T_c=25^\circ C$ unless otherwise noted

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	30	V
V_{GS}	Gate-Source Voltage	± 12	V
I_D	Drain Current - Continuous ($T_A=25^\circ C$)	6	A
I_{DM}	Drain Current - Pulsed (NOTE 1)	30	A
P_D	Power Dissipation ($T_A=25^\circ C$)	1	W
T_J	Operating Junction Temperature Range	-55 to 150	$^\circ C$
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ C$
Marking Code		AP6N03LI	

Thermal Characteristics

Symbol	Parameter	Rating	Unit
$R_{\theta JA}$	Thermal Resistance Junction to Ambient	125	$^\circ C/W$
$R_{\theta JC}$	Thermal Resistance Junction to Case	30	$^\circ C/W$

**Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)****Off Characteristics**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	30	---	---	V
I_{DSS}	Drain-Source Leakage Current	$V_{DS}=24V, V_{GS}=0V$	---	---	1	μA
I_{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$	---	---	± 100	nA

On Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS}=10V, I_D=5A$	---	---	28	m Ω
		$V_{GS}=4.5V, I_D=3A$	---	---	32	
		$V_{GS}=2.5V, I_D=1A$	---	---	45	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}, I_D=250\mu A$	0.5	---	1.5	V
gfs	Forward Transconductance	$V_{DS}=5V, I_D=5A$	---	7	---	S

Dynamic and switching Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
Q_g	Total Gate Charge	$V_{DS}=15V, V_{GS}=4.5V, I_D=5A$	---	6	---	nC
Q_{gs}	Gate-Source Charge		---	2.5	---	
Q_{gd}	Gate-Drain Charge		---	2.1	---	
$T_{d(on)}$	Turn-On Delay Time	$V_{DD}=15V, V_{GS}=10V, R_G=3.3\Omega, I_D=5A$	---	2.4	---	nS
T_r	Rise Time		---	7.8	---	
$T_{d(off)}$	Turn-Off Delay Time		---	22	---	
T_f	Fall Time		---	4	---	
C_{iss}	Input Capacitance	$V_{DS}=15V, V_{GS}=0V, F=1\text{MHz}$	---	572	---	pF
C_{oss}	Output Capacitance		---	81	---	
C_{rss}	Reverse Transfer Capacitance		---	65	---	
R_g	Gate Resistance	$V_{GS}=0V, V_{DS}=0V, F=1\text{MHz}$	---	2.5	---	Ω

Drain-Source Diode Characteristics and Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_S	Continuous Source Current	$V_G=V_D=0V, \text{Force Current}$	---	---	5.8	A
I_{SM}	Pulsed Source Current		---	---	30	A
V_{SD}	Diode Forward Voltage	$V_{GS}=0V, I_S=3A$	---	---	1.2	V

NOTES :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. The data tested by pulsed , pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.
3. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.



Characteristics Curves

FIG. 1-Output Characteristics

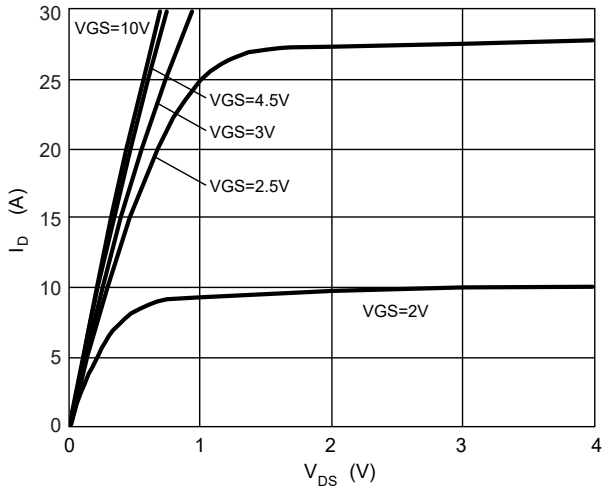


FIG. 2- $R_{DS(ON)}$ vs V_{GS}

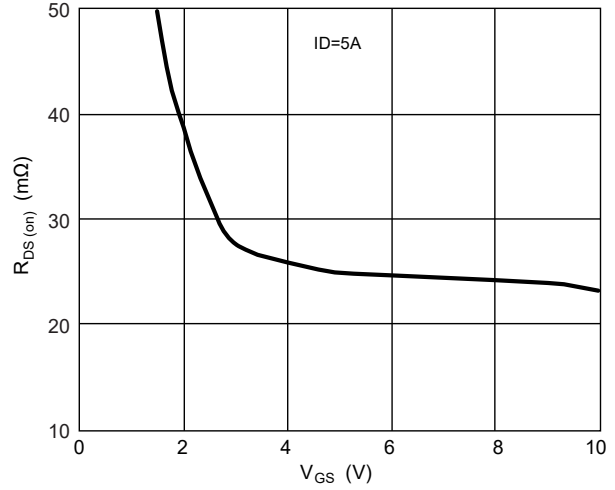


FIG. 3-Forward Characteristics of Diode

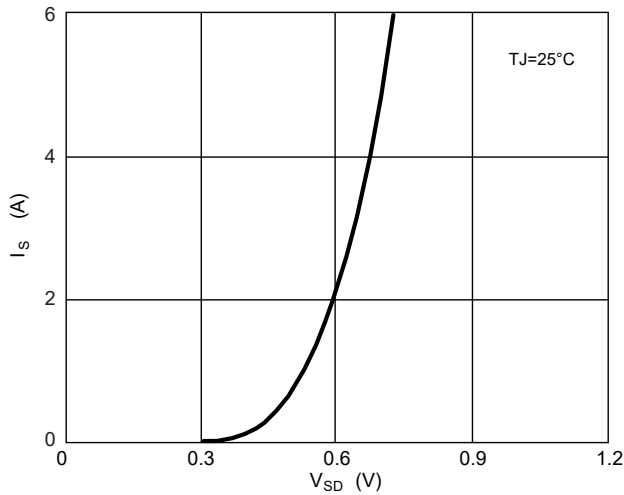


FIG. 4-Normalized $R_{DS(ON)}$ vs T_J

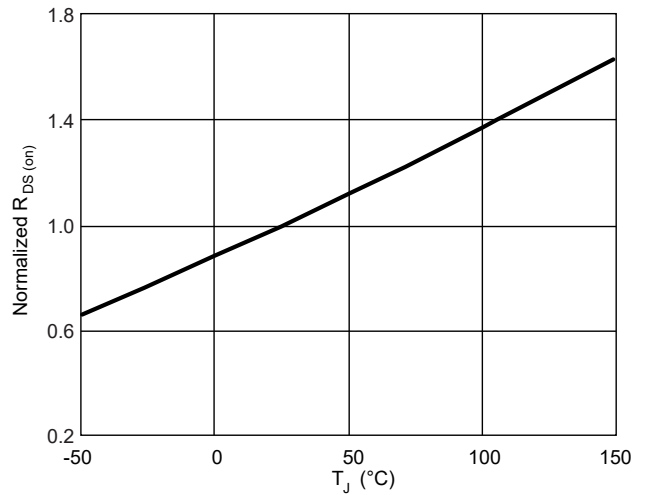


FIG. 5-Normalized $V_{GS(th)}$ vs T_J

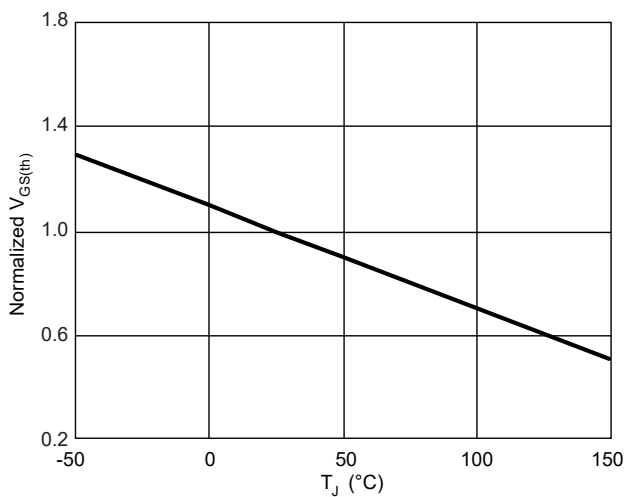
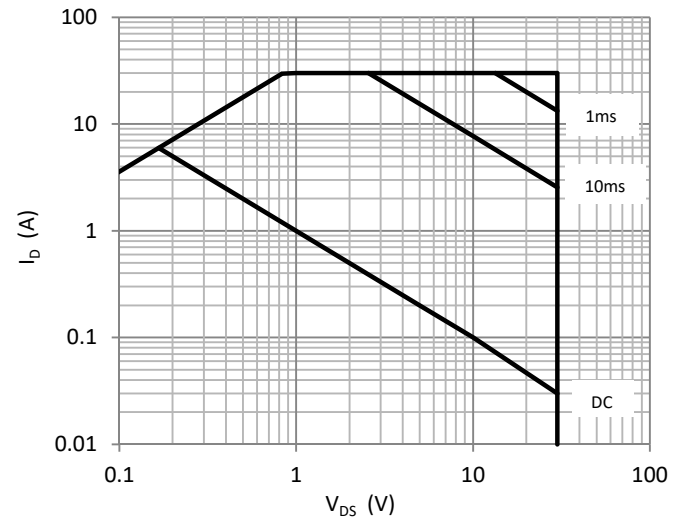


FIG. 6-Safe Operation Area





Characteristics Curves

FIG. 7-Switching Time Waveform

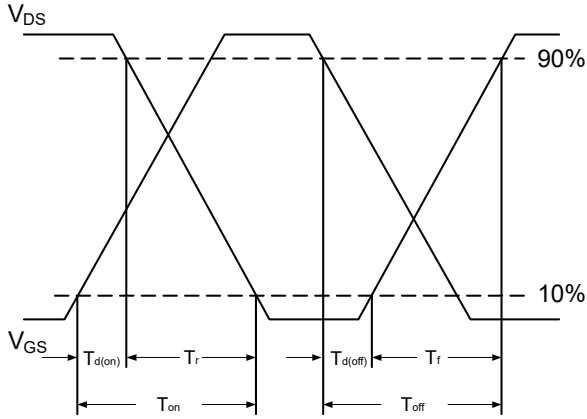
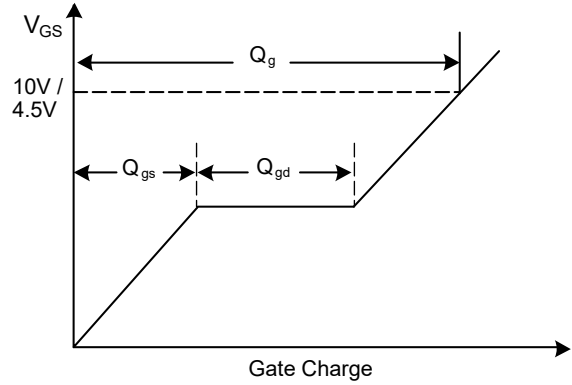
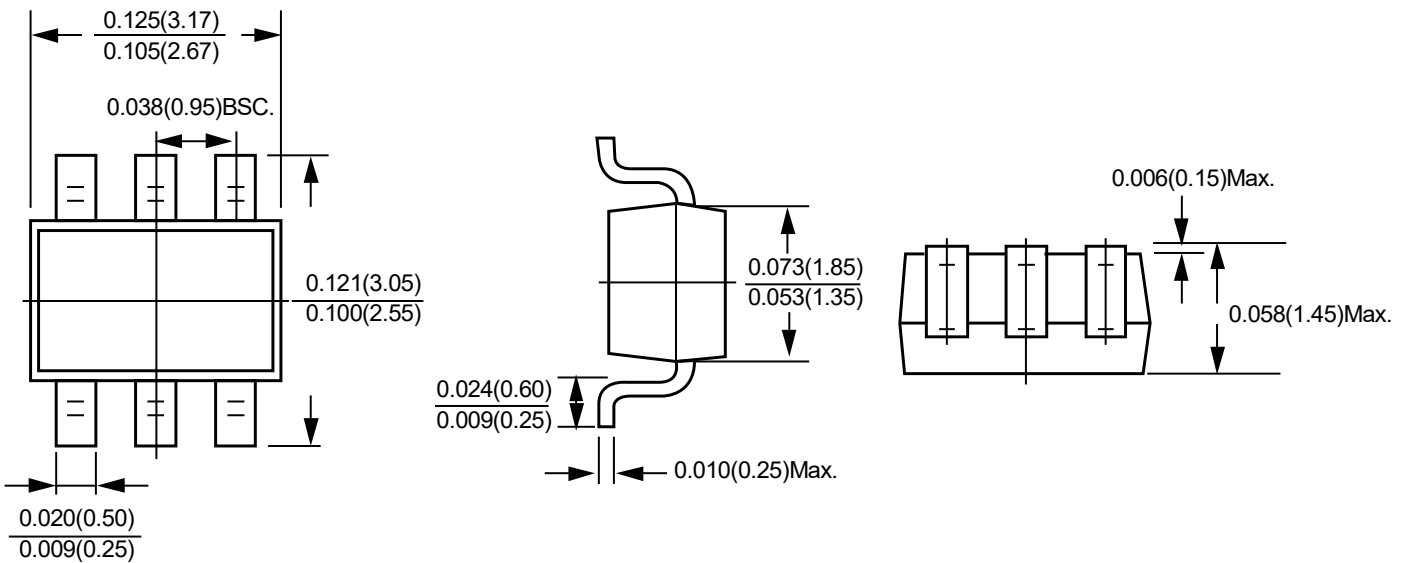


FIG. 8-Gate Charge Waveform



Package Outline Dimensions



SOT-23-6

Dimensions in inches and (millimeters)



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